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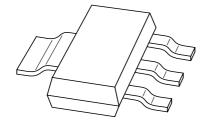
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

# **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# **BAT160 series**Schottky barrier double diodes

Product data sheet Supersedes data of 1999 Mar 26 1999 Sep 20



# Schottky barrier double diodes

# **BAT160** series

#### **FEATURES**

- · Low switching losses
- Capability of absorbing very high surge current
- · Fast recovery time
- · Guard ring protected
- Plastic SMD package.

#### **APPLICATIONS**

- Low power switched-mode power supplies
- Rectification
- · Polarity protection.

# **DESCRIPTION**

Planar Schottky barrier double diodes encapsulated in a SOT223 plastic SMD package.

# **MARKING**

TYPE NUMBER	MARKING CODE
BAT160A	AT160A
BAT160C	AT160C
BAT160S	AT160S

#### **PINNING**

PIN	BAT160						
FIIN	Α	С	S				
1	k <sub>1</sub>	a <sub>1</sub>	a <sub>1</sub>				
2	n.c.	n.c.	n.c.				
3	k <sub>2</sub>	a <sub>2</sub>	k <sub>2</sub>				
4	a <sub>1</sub> , a <sub>2</sub>	k <sub>1</sub> , k <sub>2</sub>	k <sub>1</sub> , a <sub>2</sub>				

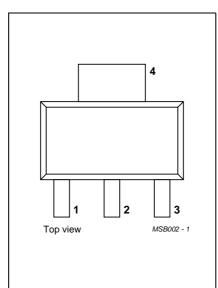


Fig.1 Simplified outline (SOT223) and pin configuration.

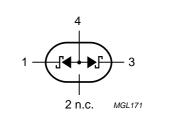
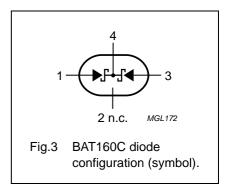


Fig.2 BAT160A diode configuration (symbol).



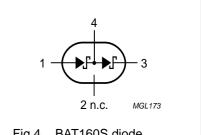


Fig.4 BAT160S diode configuration (symbol).

# Schottky barrier double diodes

BAT160 series

## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
$V_R$	continuous reverse voltage		_	60	V
I <sub>F</sub>	continuous forward current		_	1	Α
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 8.3 ms; half sinewave; JEDEC method	_	10	А
I <sub>RSM</sub>	non-repetitive peak reverse current	t <sub>p</sub> = 100 μs	_	0.5	Α
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

# **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
Per diode		·	•	•
V <sub>F</sub>	forward voltage	see Fig.5		
		I <sub>F</sub> = 100 mA	400	mV
		I <sub>F</sub> = 1 A	650	mV
		I <sub>F</sub> = 2 A	850	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 60 V; note 1; see Fig.6	350	μА
		$V_R = 60 \text{ V}; T_j = 100 ^{\circ}\text{C}; \text{ note 1};$ see Fig.6	8	mA
C <sub>d</sub>	diode capacitance	$f = 1 \text{ MHz}$ ; $V_R = 4 \text{ V}$ ; see Fig 7	60	pF

# Note

1. Pulse test:  $t_p$  = 300  $\mu$ s;  $\delta$  = 0.02.

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	100	K/W

#### Note

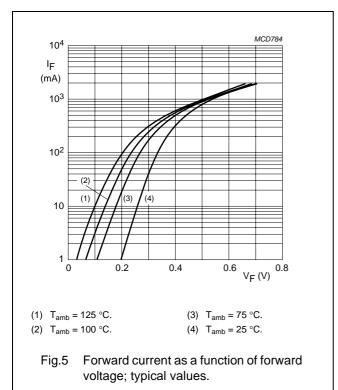
1. Refer to SOT223 standard mounting conditions.

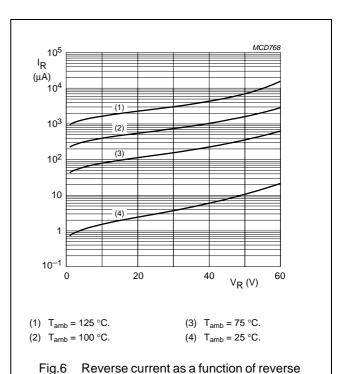
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# Schottky barrier double diodes

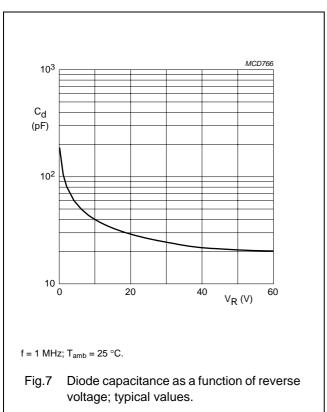
# BAT160 series

## **GRAPHICAL DATA**





voltage; typical values.



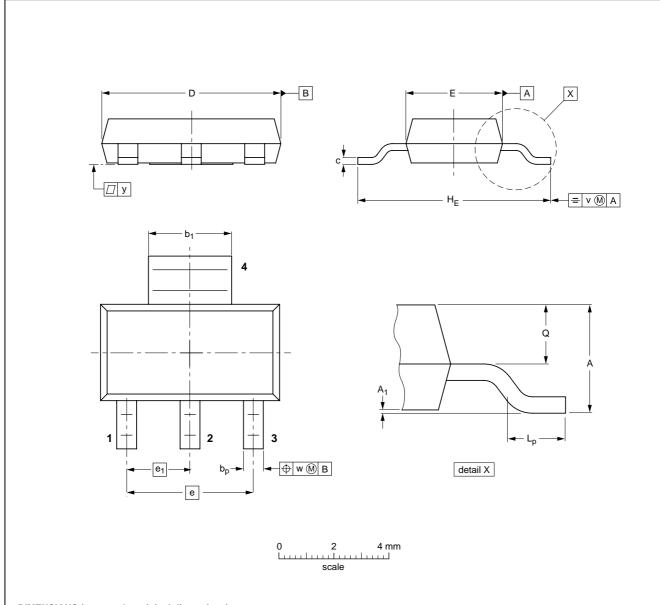
# Schottky barrier double diodes

# BAT160 series

# **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

**SOT223** 



# DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	bp	b <sub>1</sub>	С	D	E	е	e <sub>1</sub>	HE	Lp	Q	v	w	у
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	IEC JEDEC			PROJECTION	ISSUE DATE	
SOT223			SC-73			<del>-97-02-28</del> 99-09-13	

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# Schottky barrier double diodes

# **BAT160** series

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### **Notes**

- 1. Please consult the most recently issued document before initiating or completing a design.
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## **Customer notification**

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## **Contact information**

For additional information please visit: http://www.nxp.com

For sales offices addresses send e-mail to: salesaddresses@nxp.com

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